

RP130x Series

Low Noise 150 mA LDO Regulator

No. EA-173-230725

OUTLINE

The RP130x is a voltage regulator IC with high ripple rejection, low dropout voltage, high output voltage accuracy and extremely low supply current. The IC consists of a voltage reference unit, an error amplifier, a resistor-net for voltage setting, a short current limit circuit and a chip enable circuit.

This IC has an excellent low supply current performed by CMOS process, moreover they perform with low dropout voltage due to built-in low on-resistance. A chip enable function prolongs the battery life.

The input transient response, the load transient response and the ripple rejection have been improved in the RP130x compared with the conventional products. Besides achieving low supply current (Typ.38 µA).

The range of the operation voltage is capable from 1.7 V to 6.5 V and the range of the output voltage is capable from 1.2 V to 5.3 V for this product, which is wider range as our conventional product R1114x.

The output voltage of this IC is fixed with high accuracy. Since the packages for this IC are DFN(PL)1010-4, SOT-23-5 and SC-82AB, therefore high density mounting of the IC on board is possible.

FEATURES

Supply CurrentTyp	ο. 38 μΑ
Standby CurrentTyp	ο. 0.1 μΑ
Ripple RejectionTyp	o. 80 dB (f = 1 kHz)
Input Voltage Range (Maximum Rating)1.7	' V to 6.5 V (7.0 V)
Output Voltage Range1.2	! V to 5.3 V (0.1 V step ⁽¹⁾)
Output Voltage Accuracy±1.	.0% (V _{OUT} > 2.0 V, Ta = 25°C)
Temperature-Drift Coefficient of Output Voltage Typ	o. ±20 ppm/°C
Dropout VoltageTyp	o. $0.32 \text{ V} (I_{\text{OUT}} = 150 \text{ mA}, V_{\text{OUT}} = 2.8 \text{ V})$
Line RegulationTyp	o. 0.02%/V
PackagesDF	N(PL)1010-4, SC-82AB, SOT-23-5
Built-in Fold Back Protection CircuitTyp	o. 40 mA
• Ceramic capacitors are recommended to be used with thi	is IC0.47 μF or more

APPLICATIONS

- Power source for battery-powered equipment.
- Power source for portable communication equipment.
- Power source for electrical appliances such as cameras, VCRs and camcorders.
- Power source for high stable reference voltage.

⁽¹⁾ For other voltages, please refer to SELECTION GUIDE.

SELECTION GUIDE

The set output voltage, chip enable polarity, auto-discharge function⁽¹⁾, and packages for the IC can be selected at the user's request.

Selection Guide

Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP130Kxx1*-TR	DFN(PL)1010-4	10,000 pcs	Yes	Yes
RP130Qxx1*-TR-FE	SC-82AB	3,000 pcs	Yes	Yes
RP130Nxx1*-TR-FE	SOT-23-5	3,000 pcs	Yes	Yes

xx : Set Output Voltage (VSET)

Fixed Type: 12 to 53 Stepwise setting with 0.1 V increment in the range from 1.2 V to 5.3 V

Exception: 1.25 V = RP130x121*5

1.85 V = RP130x181*5

2.85 V = RP130x281*5

3.45 V = RP130x341*5

4.25 V = RP130x421*5

* : CE pin polarity and auto-discharge function at off state are options as follows.

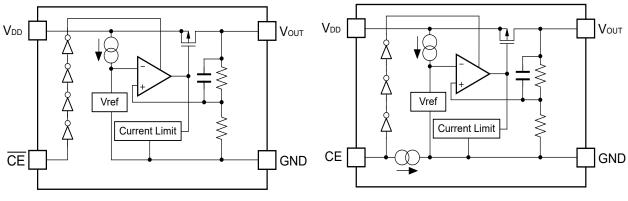
A: active low, without auto-discharge function at off state.

B: active high, without auto-discharge function at off state.

D: active high, with auto-discharge function at off state.

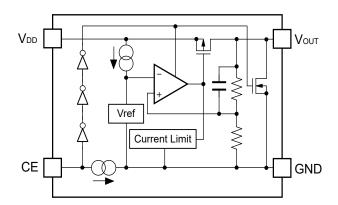
⁽¹⁾ Auto-discharge function quickly lowers the output voltage to 0 V by releasing the electrical charge in the external capacitor when the chip enable signal is switched from the active mode to the standby mode.

BLOCK DIAGRAMS



RP130xxx1A Block Diagram

RP130xxx1B Block Diagram

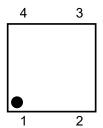


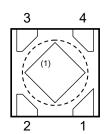
RP130xxx1D Block Diagram

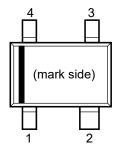
PIN DESCRIPTIONS

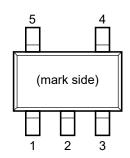
Top View

Bottom View









DFN(PL)1010-4 Pin Configuration

SC-82AB Pin Configuration

SOT-23-5 Pin Configuration

DFN(PL)1010-4 Pin Description

Pin No	Symbol	Pin Description
1	VOUT	Output Pin
2	GND	Ground Pin
3	CE / CE	Chip Enable Pin ("L" Active / "H" Active)
4	VDD	Input Pin

SC-82AB Pin Description

Pin No	Symbol	Pin Description			
1	CE / CE	Chip Enable Pin ("L" Active / "H" Active)			
2	GND	Ground Pin			
3	VOUT	Output Pin			
4	VDD	Input Pin			

SOT-23-5 Pin Description

Pin No	Symbol	Pin Description
1	VDD	Input Pin
2	GND	Ground Pin
3	CE / CE	Chip Enable Pin ("L" Active / "H" Active)
4	NC	No Connection
5	VOUT	Output Pin

⁽¹⁾ Tab is GND level (they are connected to the reverse side of this IC). The tab is better to be connected to the GND, but leaving it open is also acceptable.

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings

Symbol		Item		Rating	Unit
Vin	Input Voltage			7.0	V
Vce	Input Voltage (CE	Pin)		-0.3 to 7.0	V
Vout	Output Voltage			-0.3 to $V_{IN} + 0.3$	V
l _{out}	Output Current	Output Current			
		DFN(PL)1010-4	JEDEC STD. 51-7 Test Land Pattern	800	
P_{D}	Power Dissipation ⁽¹⁾	SC-82AB	Standard Test Land Pattern	380	mW
		SOT-23-5	JEDEC STD. 51-7 Test Land Pattern	660	
Tj	Junction Temperature Range			-40 to 125	°C
Tstg	Storage Temperature Range			-55 to 125	°C

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the lifetime and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings are not assured.

RECOMMENDED OPERATING CONDITIONS

Recommended Operating Conditions

Symbol	Item	Rating	Unit
V _{IN}	Input Voltage	1.7 to 6.5	V
Та	Operating Temperature Range	-40 to 85	°C

RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

⁽¹⁾ Refer to POWER DISSIPATION for detailed information.

ELECTRICAL CHARACTERISTICS

 $V_{\text{IN}} = V_{\text{SET}} + 1 \text{ V (V}_{\text{OUT}} > 1.5 \text{ V)}, V_{\text{IN}} = 2.5 \text{ V (V}_{\text{OUT}} \le 1.5 \text{ V)}, I_{\text{OUT}} = 1 \text{ mA}, C_{\text{IN}} = C_{\text{OUT}} = 0.47 \,\mu\text{F},$ unless otherwise noted. The specifications surrounded by _____ are guaranteed by design engineering at $-40^{\circ}\text{C} \le \text{Ta} \le 85^{\circ}\text{C}$.

RP130xxx1A Electrical Characteristics

(Ta = 25°C)

RPTSUXX	P130XXX1A Electrical Characteristics (1a = 25°C)							
Symbol	Item	Co	nditi	ons	Min.	Тур.	Max.	Unit
		Ta = 25°C		V _{SET} > 2.0 V	x 0.99		x 1.01	V
V	Output Valtage	V _{SET} ≤ 2.0 V		-20		20	mV	
Vout	Output Voltage	-40°C ≤ Ta ≤ 8	1000 17 10500 V		x0.985		x1.015	V
		-40 C \(\) \(\) \(\) \(\)	5 C	V _{SET} ≤ 2.0 V	-30		30	mV
I _{LIM}	Output Current Limit				150			mA
ΔV_{OUT}	Load Regulation	1 mA ≤ I _{OUT} ≤ 1	50 m	A		10	30	mV
			1.2	V ≤ V _{SET} < 1.5 V		0.67	1.00	
			1.5	V ≤ V _{SET} < 1.7 V		0.54	0.81	
V_{DIF}	Dropout Voltage	I _{OUT} = 150 mA	1.7	V ≤ V _{SET} < 2.0 V		0.46	0.68	V
V DIF	Diopout Voltage	TOUT - TOUTHA	2.0	V ≤ V _{SET} < 2.5 V		0.41	0.60	V
			2.5	V ≤ V _{SET} < 4.0 V		0.32	0.51	
			4.0	V ≤ V _{SET}		0.24	0.37	<u> </u>
Iss	Supply Current	I _{OUT} = 0 mA	I _{OUT} = 0 mA			38	58	μΑ
Istandby	Supply Current (Standby)	V _{CE} = V _{IN}	V _{CE} = V _{IN}			0.1	1.0	μΑ
ΔV_{OUT} / ΔV_{IN}	Line Regulation	V _{SET} + 0.5 V ≤	V _{IN} ≤	6.5 V		0.02	0.10	%/V
RR	Ripple Rejection	f = 1 kHz, Ripple 0.2 Vp-p $V_{IN} = V_{SET} + 1 V$ $I_{OUT} = 30 \text{ mA (In case that } V_{OUT} \le 2.0 \text{ V}, V_{IN} = 3.0 \text{ V})$			80		dB	
VIN	Input Voltage				1.7		6.5	V
ΔV _{OUT} /ΔTa	Output Voltage Temperature Coefficient	-40°C ≤ Ta ≤ 85°C			±20		ppm /°C	
Isc	Short Current Limit	V _{OUT} = 0 V			40		mA	
Vceh	CE Input Voltage "H"			1.0			μΑ	
V_{CEL}	CE Input Voltage "L"					0.4		
en	Output Noise	BW = 10 Hz to I _{OUT} = 30 mA	BW = 10 Hz to 100 kHz lout = 30 mA			20 xV _{SET}		μVrms

All test items listed under *Electrical Characteristics* are done under the pulse load condition (Tj \approx Ta = 25°C) except for Output Noise, Ripple Rejection, and Output Voltage Temperature Coefficient.

ELECTRICAL CHARACTERISTICS (continued)

 V_{IN} = V_{SET} + 1 V (V_{OUT} > 1.5 V), V_{IN} = 2.5 V (V_{OUT} \leq 1.5 V), I_{OUT} = 1 mA, C_{IN} = C_{OUT} = 0.47 μ F, unless otherwise noted.

The specifications surrounded by are guaranteed by design engineering at −40°C ≤ Ta ≤ 85°C.

	x1B/D Electrical Characte					ı	,	= 25°C)
Symbol	Item	Conditions			Min.	Тур.	Max.	Unit
		Ta = 25°C		V _{SET} > 2.0 V	x 0.99		x 1.01	V
Vout	Output Voltage	1a = 25 C	1a - 25 C		-20		20	mV
Vooi Output Voita	Output Voltage	-40°C ≤ Ta ≤ 8	5°C	V _{SET} > 2.0 V	x 0.985		x 1.015	V
		-40 C S 1a S 0	<i>5</i> C	V _{SET} ≤ 2.0 V	-30		30	mV
I _{LIM}	Output Current Limit				150			mA
Δ V ουτ /Δ I ουτ	Load Regulation	1 mA ≤ I _{OUT} ≤ 1	50 m	ıΑ		10	30	mV
			1.2	V ≤ V _{SET} < 1.5 V		0.67	1.00	
			1.5	V ≤ V _{SET} < 1.7 V		0.54	0.81	
V_{DIF}	Dropout Voltage	I _{OUT} = 150 mA	1.7	V ≤ V _{SET} < 2.0 V		0.46	0.68	
V DIF	Dropout Voltage	IOUT – IOU IIIA	2.0	V ≤ V _{SET} < 2.5 V		0.41	0.60	
			2.5	V ≤ V _{SET} < 4.0 V		0.32	0.51	
			4.0	V ≤ V _{SET}		0.24	0.37	
I _{SS}	Supply Current	I _{OUT} = 0 mA				38	58	μΑ
Istandby	Standby Current	V _{CE} = 0 V				0.1	1.0	μΑ
ΔV _{OUT} /ΔV _{IN}	Line Regulation	V _{SET} + 0.5 V ≤ \	V _{IN} ≤	6.5 V		0.02	0.10	%/V
RR	Ripple Rejection	f = 1 kHz, Rippl V _{IN} = V _{SET} + 1 \ case that V _{OUT} :	/, I _{OU}	⊤ = 30 mA (In		80		dB
VIN	Input Voltage				1.7		6.5	V
ΔV _{ουτ} /ΔTa	Output Voltage Temperature Coefficient	-40°C ≤ Ta ≤ 8	5°C			±20		ppm /°C
Isc	Short Current Limit	V _{OUT} = 0 V				40		mA
I _{PD}	CE Pull-down Current				0.4		μΑ	
VCEH	CE Input Voltage "H"			1.0			μΑ	
VCEL	CE Input Voltage "L"						0.4	
en	Output Noise	BW = 10 Hz to 100 kHz I _{OUT} = 30 mA			20 xV _{SET}		μVrms	
R _{LOW}	Nch ON Resistance for Auto Discharge (RP130xxx1D)	V _{IN} = 4.0 V V _{CE} = 0 V	V _{IN} = 4.0 V			30		Ω

All test items listed under *Electrical Characteristics* are done under the pulse load condition (Tj≈Ta=25°C) except for Output Noise, Ripple Rejection, and Output Voltage Temperature Coefficient.

The specifications surrounded by \square are guaranteed by design engineering at -40° C \leq Ta \leq 85 $^{\circ}$ C.

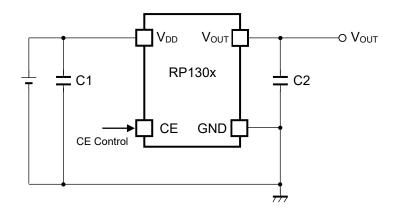
Product-specific Electrical Characteristics

(Ta = 25°C)

Product Name		V _{OUT} [V] (Ta = 25°C)		(Та :	V _{OUT} [V] = −40°C to 8	5°C)	V _{DIF}	: [V]
	Min.	Тур.	Max.	Min.	Тур.	Max.	Тур.	Max.
RP130x121x	1.180	1.2	1.220	1.170	1.2	1.230		
RP130x121x5	1.230	1.25	1.270	1.220	1.25	1.280	0.67	1.00
RP130x131x	1.280	1.3	1.320	1.270	1.3	1.330		
RP130x141x	1.380	1.4	1.420	1.370	1.4	1.430		
RP130x151x	1.480	1.5	1.520	1.470	1.5	1.530	0.54	0.81
RP130x161x	1.580	1.6	1.620	1.570	1.6	1.630	0.54	0.61
RP130x171x	1.680	1.7	1.720	1.670	1.7	1.730		
RP130x181x	1.780	1.8	1.820	1.770	1.8	1.830	0.46	0.00
RP130x181x5	1.830	1.85	1.870	1.820	1.85	1.880	0.46	0.68
RP130x191x	1.880	1.9	1.920	1.870	1.9	1.930		
RP130x201x	1.980	2.0	2.020	1.970	2.0	2.030		
RP130x211x	2.079	2.1	2.121	2.069	2.1	2.132		
RP130x221x	2.178	2.2	2.222	2.167	2.2	2.233	0.41	0.60
RP130x231x	2.277	2.3	2.323	2.266	2.3	2.335		
RP130x241x	2.376	2.4	2.424	2.364	2.4	2.436		
RP130x251x	2.475	2.5	2.525	2.463	2.5	2.538		
RP130x261x	2.574	2.6	2.626	2.561	2.6	2.639		
RP130x271x	2.673	2.7	2.727	2.660	2.7	2.741		0.51
RP130x281x	2.772	2.8	2.828	2.758	2.8	2.842		
RP130x281x5	2.822	2.85	2.879	2.807	2.85	2.893		
RP130x291x	2.871	2.9	2.929	2.857	2.9	2.944		
RP130x301x	2.970	3.0	3.030	2.955	3.0	3.045		
RP130x311x	3.069	3.1	3.131	3.054	3.1	3.147		
RP130x321x	3.168	3.2	3.232	3.152	3.2	3.248	0.32	
RP130x331x	3.267	3.3	3.333	3.251	3.3	3.350		
RP130x341x	3.366	3.4	3.434	3.349	3.4	3.451		
RP130x341x5	3.416	3.45	3.485	3.398	3.45	3.502		
RP130x351x	3.465	3.5	3.535	3.448	3.5	3.553		
RP130x361x	3.564	3.6	3.636	3.546	3.6	3.654		
RP130x371x	3.663	3.7	3.737	3.645	3.7	3.756		
RP130x381x	3.762	3.8	3.838	3.743	3.8	3.857		
RP130x391x	3.861	3.9	3.939	3.842	3.9	3.959		
RP130x401x	3.960	4.0	4.040	3.940	4.0	4.060		
RP130x411x	4.059	4.1	4.141	4.039	4.1	4.162		
RP130x421x	4.158	4.2	4.242	4.137	4.2	4.263		
RP130x421x5	4.208	4.25	4.293	4.186	4.25	4.314		
RP130x431x	4.257	4.3	4.343	4.236	4.3	4.365		
RP130x441x	4.356	4.4	4.444	4.334	4.4	4.466	0.24	
RP130x451x	4.455	4.5	4.545	4.433	4.5	4.568		
RP130x461x	4.554	4.6	4.646	4.531	4.6	4.669		0.37
RP130x471x	4.653	4.7	4.747	4.630	4.7	4.771		
RP130x481x	4.752	4.8	4.848	4.728	4.8	4.872		
RP130x491x	4.851	4.9	4.949	4.827	4.9	4.974		
RP130x501x	4.950	5.0	5.050	4.925	5.0	5.075]	
RP130x511x	5.049	5.1	5.151	5.024	5.1	5.177]	
RP130x521x	5.148	5.2	5.252	5.122	5.2	5.278]	
RP130x531x	5.247	5.3	5.353	5.221	5.3	5.380	<u> </u>	

APPLICATION INFORMATION

TYPICAL APPLICATION



RP130x Typical Application

External Components

Symbol	Descriptions
C1, C2	0.47 μF, Ceramic Capacitor, Murata, GRM155B30J474KE18B

TECHNICAL NOTES

Phase Compensation

In these ICs, phase compensation is made for securing stable operation even if the load current is varied. For this purpose, use a capacitor C2 with 0.47 μ F or more. If a tantalum capacitor is used, and its ESR (Equivalent Series Resistance) of C2 is large, the loop oscillation may result. Because of this, select C2 carefully considering its frequency characteristics.

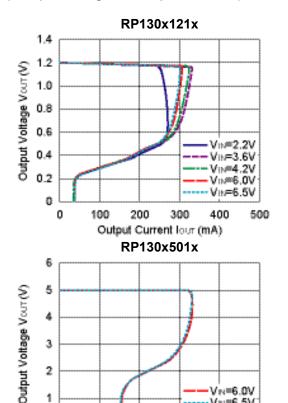
PCB Layout

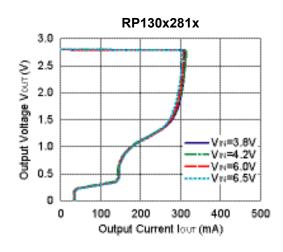
Make VDD and GND lines sufficient. If their impedance is high, noise pickup or unstable operation may result. Connect a capacitor C1 with a capacitance value as much as 0.47 μ F or more between VDD and GND pin, and as close as possible to the pins. Set external components, especially the output capacitor C2, as close as possible to the ICs, and make wiring as short as possible.

TYPICAL CHARACTERISTICS

Typical characteristics are intended to be used as reference data, they are not guaranteed.

1) Output Voltage vs. Output Current (C1 = 0.47 μ F, C2 = 0.47 μ F, Ta = 25°C)



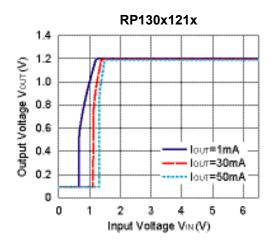


2) Output Voltage vs. Input Voltage (C1 = 0.47 μ F, C2 = 0.47 μ F, Ta = 25°C)

400

V≈≈6.5V

500

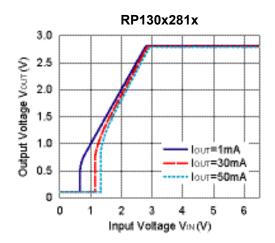


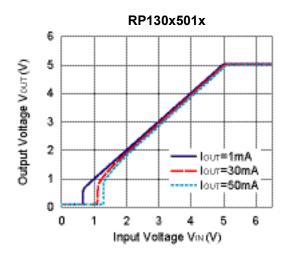
200

300

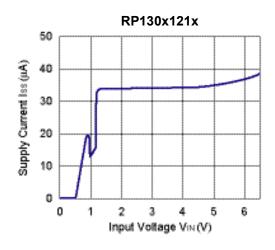
Output Current lour (mA)

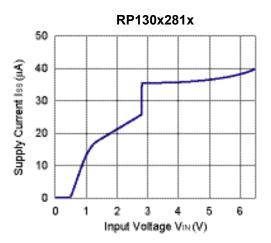
0 Ö

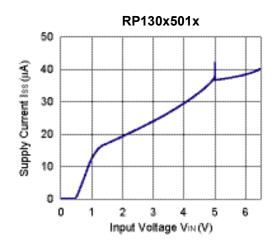




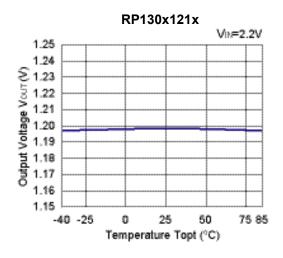
3) Supply Current vs. Input Voltage (C1 = 0.47 μ F, C2 = 0.47 μ F, Ta = 25°C)

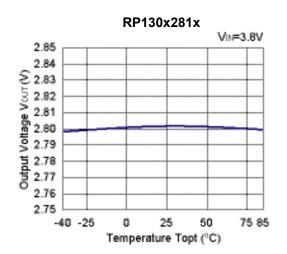


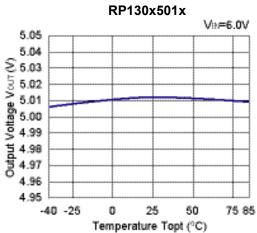




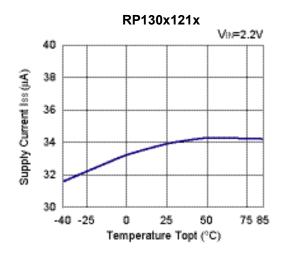
4) Output Voltage vs. Temperature (I_{OUT} = 1 mA, C1 = 0.47 μ F, C2 = 0.47 μ F)

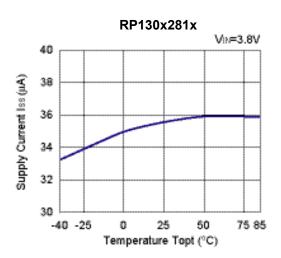


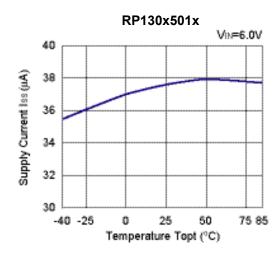




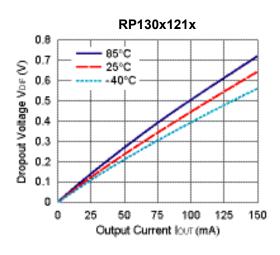
5) Supply Current vs. Temperature (IOUT = 0 mA, C1 = 0.47 μ F, C2 = 0.47 μ F)

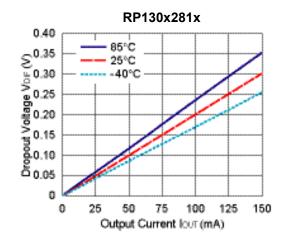


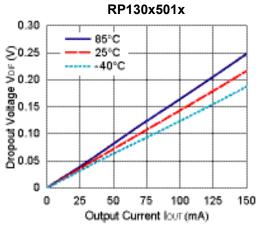




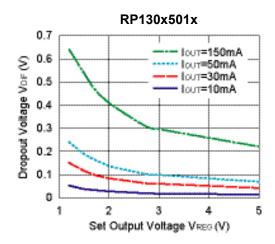
6) Dropout Voltage vs. Output Current (C1 = 0.47 μ F, C2 = 0.47 μ F)



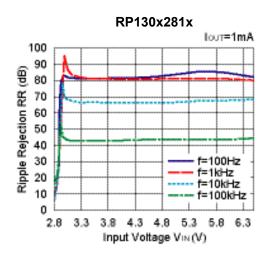


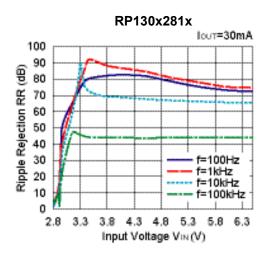


7) Dropout Voltage vs. Set Output Voltage (C1 = 0.47 μ F, C2 = 0.47 μ F)

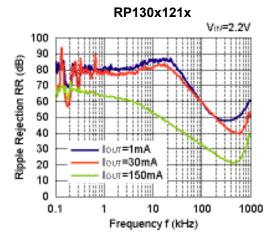


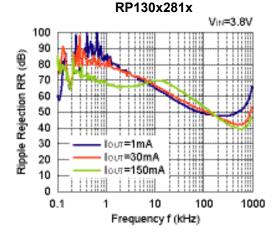
8) Ripple Rejection vs. Input Bias Voltage (C1 = none, C2 = 0.47 μ F, Ripple = 0.2 Vp-p, Ta = 25°C)

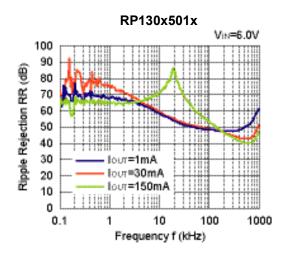




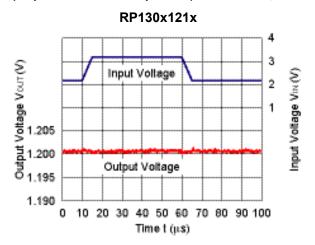
9) Ripple Rejection vs. Frequency (C1 = none, C2 = 0.47 μ F, Ripple = 0.2 Vp-p, Ta = 25°C)

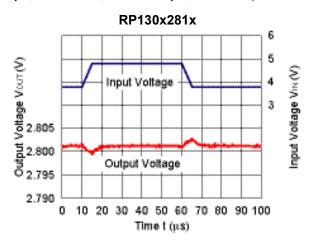


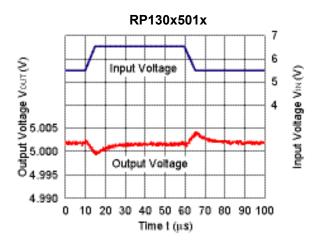




10) Input Transient Response (I_{OUT} = 30 mA, tr = tf = 5 μ s, C1 = none, C2 = 0.47 μ F, Ta = 25°C)

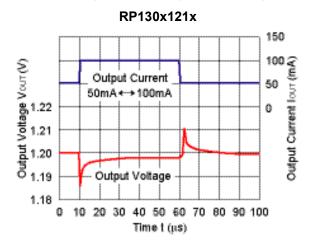


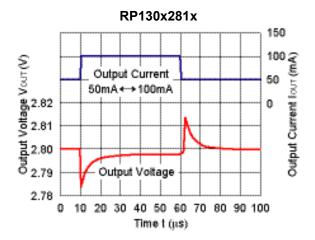


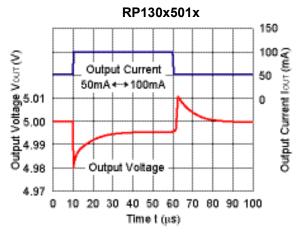


11) Load Transient Response

(tr = tf = 0.5 μ s, C1 = 0.47 μ F, C2 = 0.47 μ F, I_{OUT} = 50mA \leftrightarrow 100 mA, Ta = 25°C)

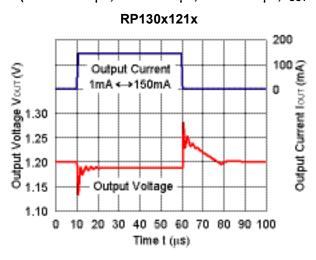


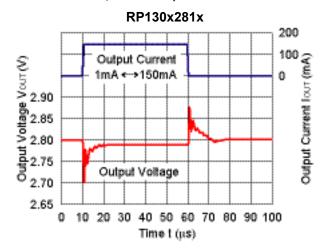


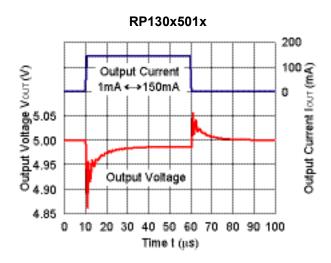


12) Load Transient Response

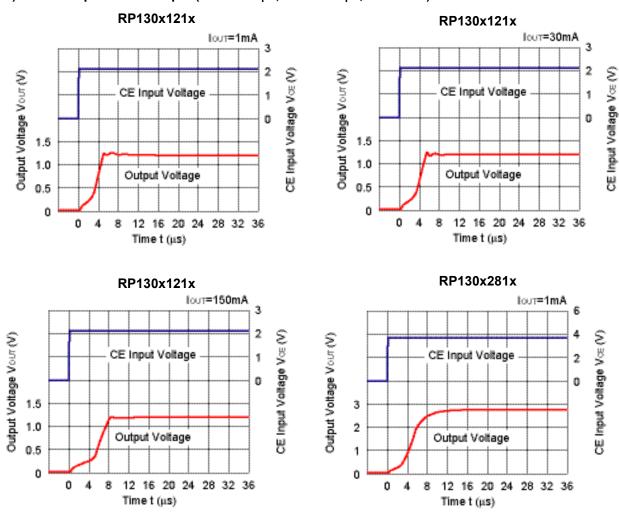
(tr = tf = 0.5 μ s, C1 = 0.47 μ F, C2 = 0.47 μ F, I_{OUT} = 1 mA \leftrightarrow 150mA, Ta = 25°C)

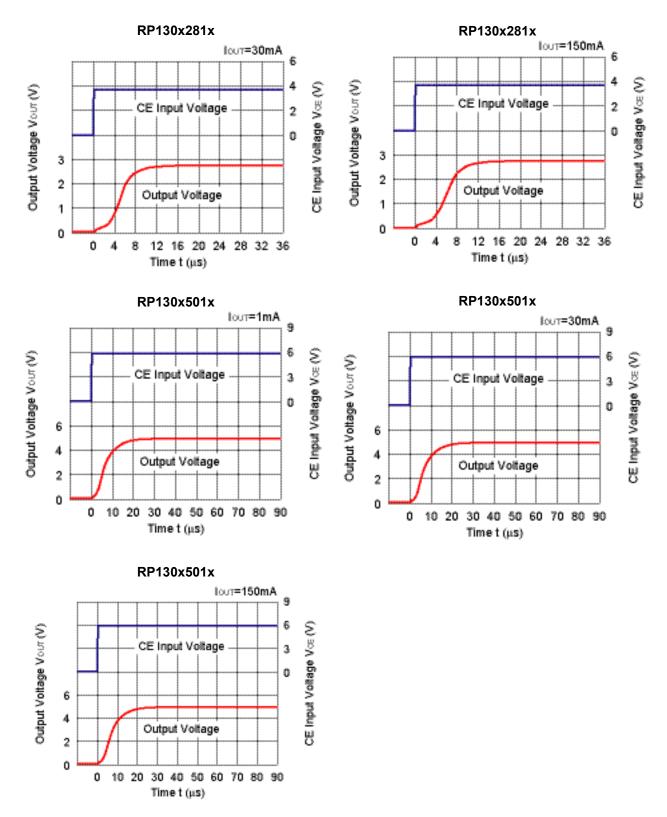




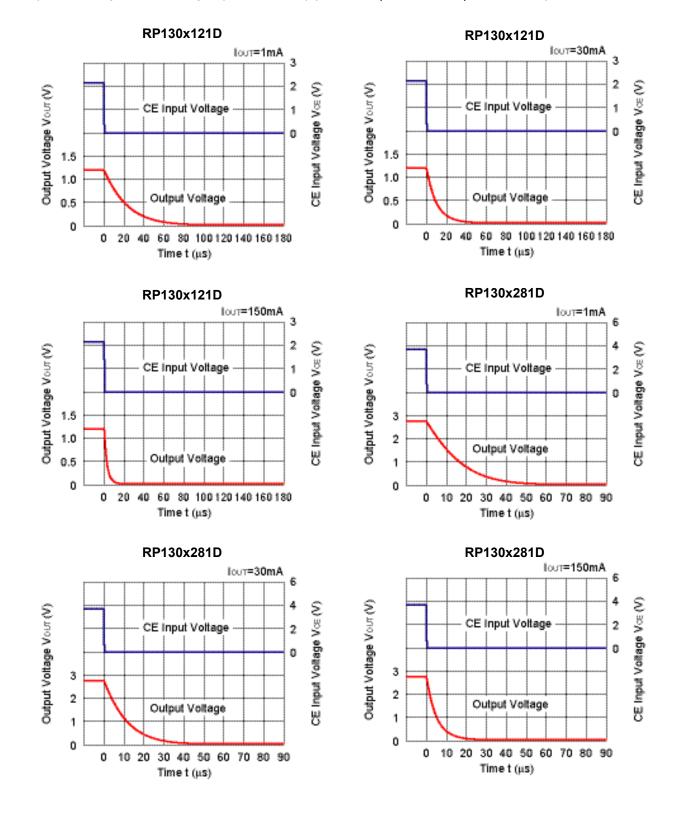


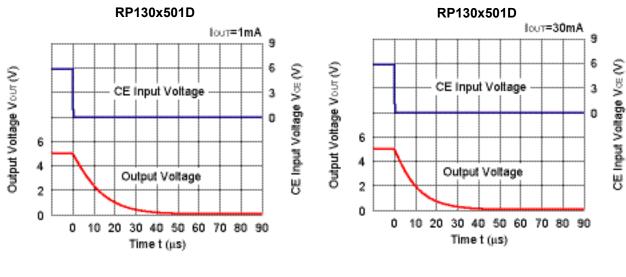
13) Turn On Speed with CE pin (C1 = 0.47 μ F, C2 = 0.47 μ F, Ta = 25°C)

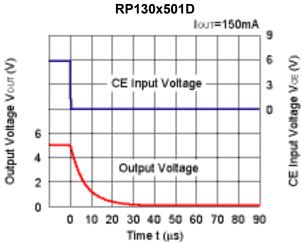




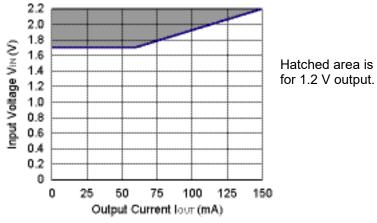
14) Turn Off Speed with CE pin (RP130xxx1D) (C1 = 0.47 μ F, C2 = 0.47 μ F, Ta = 25°C)







15) Minimum Operating Voltage (C1 = 0.47 μ F, C2 = 0.47 μ F)



Hatched area is available

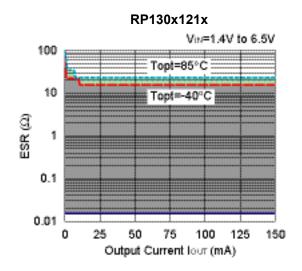
ESR vs. Output Current

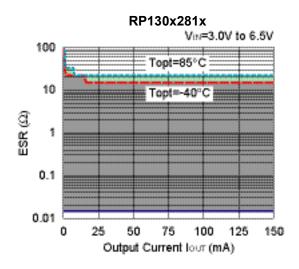
When using these ICs, consider the following points:

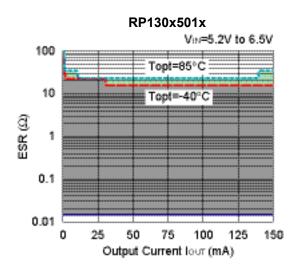
The relations between I_{OUT} (Output Current) and ESR of an output capacitor are shown below. The conditions when the white noise level is under 40 μV (Avg.) are marked as the hatched area in the graph.

Measurement conditions

Frequency Band : 10 Hz to 3 MHz Temperature : –40°C to 85°C C1, C2 : 0.47 μF







PD-DFN(PL)1010-4-(85125150)-JE-B

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
	Outer Layer (First Layer): Less than 95% of 50 mm Square
Copper Ratio	Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square
	Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.2 mm × 21 pcs

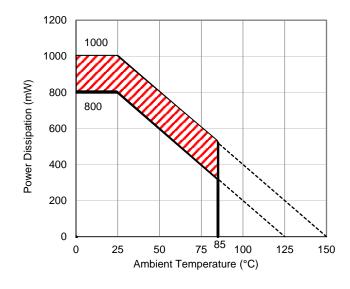
Measurement Result

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

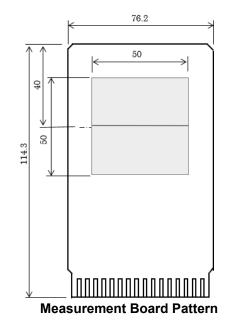
Item	Measurement Result
Power Dissipation	800 mW
Thermal Resistance (θja)	θja = 125°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 58°C/W

 θ ja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature

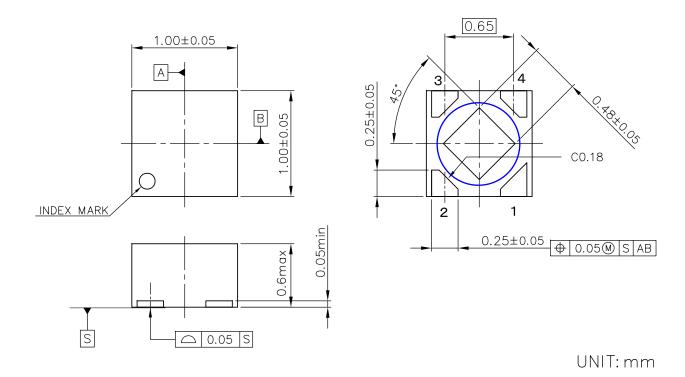


The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

Ver. B

i



DFN(PL)1010-4 Package Dimensions

^{*} The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.

Ver A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following conditions are used in this measurement.

Measurement Conditions

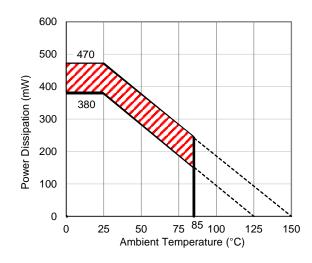
Item	Standard Land Pattern
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Double-Sided Board)
Board Dimensions	40 mm × 40 mm × 1.6 mm
Copper Ratio	Top Side: Approx. 50%
	Bottom Side: Approx. 50%
Through-holes	φ 0.5 mm × 44 pcs

Measurement Result

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

Item	Standard Land Pattern
Power Dissipation	380 mW
Thermal Resistance (θja)	θja = 263°C/W

θja: Junction-to-Ambient Thermal Resistance



40

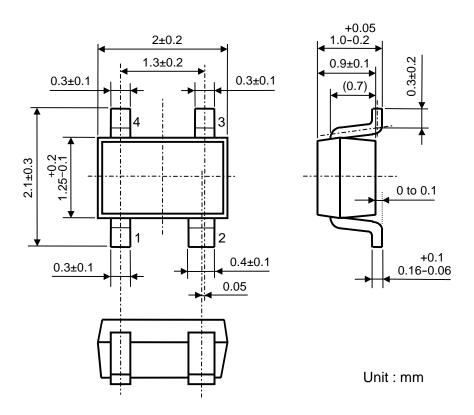
Power Dissipation vs. Ambient Temperature

Measurement Board Pattern

The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

Ver. A



SC-82AB Package Dimensions

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

Measurement Conditions

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 7 pcs

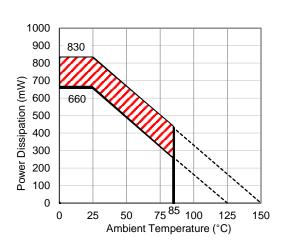
Measurement Result

 $(Ta = 25^{\circ}C, Tjmax = 125^{\circ}C)$

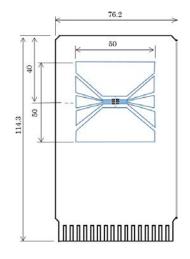
Item	Measurement Result
Power Dissipation	660 mW
Thermal Resistance (θja)	θja = 150°C/W
Thermal Characterization Parameter (ψjt)	ψjt = 51°C/W

θja: Junction-to-Ambient Thermal Resistance

ψjt: Junction-to-Top Thermal Characterization Parameter



Power Dissipation vs. Ambient Temperature



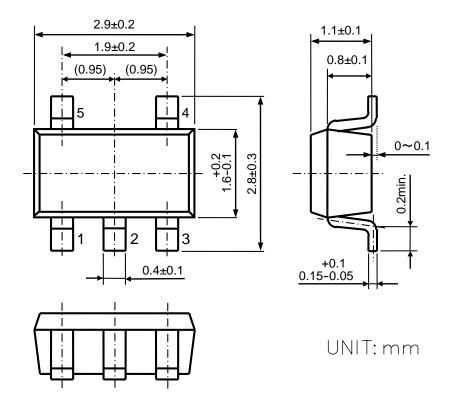
Measurement Board Pattern

The above graph shows the power dissipation of the package at Tjmax = 125°C and Tjmax = 150°C. Operating the device in the hatched range might have a negative influence on its lifetime. The total hours of use and the total years of use must be limited as follows:

Total Hours of Use	Total Years of Use (4 hours/day)
13,000 hours	9 years

I

Ver. A



SOT-23-5 Package Dimensions

- 1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to our sales representatives for the latest information thereon
- 2. The materials in this document may not be copied or otherwise reproduced in whole or in part without the prior written consent of us.
- 3. This product and any technical information relating thereto are subject to complementary export controls (so-called KNOW controls) under the Foreign Exchange and Foreign Trade Law, and related politics ministerial ordinance of the law. (Note that the complementary export controls are inapplicable to any application-specific products, except rockets and pilotless aircraft, that are insusceptible to design or program changes.) Accordingly, when exporting or carrying abroad this product, follow the Foreign Exchange and Foreign Trade Control Law and its related regulations with respect to the complementary export controls.
- 4. The technical information described in this document shows typical characteristics and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under our or any third party's intellectual property rights or any other rights.
- 5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death should first contact us.
 - Aerospace Equipment
 - Equipment Used in the Deep Sea
 - · Power Generator Control Equipment (nuclear, steam, hydraulic, etc.)
 - · Life Maintenance Medical Equipment
 - · Fire Alarms / Intruder Detectors
 - Vehicle Control Equipment (automotive, airplane, railroad, ship, etc.)
 - Various Safety Devices
 - · Traffic control system
 - Combustion equipment

In case your company desires to use this product for any applications other than general electronic equipment mentioned above, make sure to contact our company in advance. Note that the important requirements mentioned in this section are not applicable to cases where operation requirements such as application conditions are confirmed by our company in writing after consultation with your company.

- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. The products have been designed and tested to function within controlled environmental conditions. Do not use products under conditions that deviate from methods or applications specified in this datasheet. Failure to employ the products in the proper applications can lead to deterioration, destruction or failure of the products. We shall not be responsible for any bodily injury, fires or accident, property damage or any consequential damages resulting from misuse or misapplication of the products.
- 8. Quality Warranty
 - 8-1. Quality Warranty Period
 - In the case of a product purchased through an authorized distributor or directly from us, the warranty period for this product shall be one (1) year after delivery to your company. For defective products that occurred during this period, we will take the quality warranty measures described in section 8-2. However, if there is an agreement on the warranty period in the basic transaction agreement, quality assurance agreement, delivery specifications, etc., it shall be followed.
 - 8-2. Quality Warranty Remedies
 - When it has been proved defective due to manufacturing factors as a result of defect analysis by us, we will either deliver a substitute for the defective product or refund the purchase price of the defective product.
 - Note that such delivery or refund is sole and exclusive remedies to your company for the defective product.
 - 8-3. Remedies after Quality Warranty Period
 - With respect to any defect of this product found after the quality warranty period, the defect will be analyzed by us. On the basis of the defect analysis results, the scope and amounts of damage shall be determined by mutual agreement of both parties. Then we will deal with upper limit in Section 8-2. This provision is not intended to limit any legal rights of your company.
- 9. Anti-radiation design is not implemented in the products described in this document.
- 10. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 11. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 12. Warning for handling Gallium and Arsenic (GaAs) products (Applying to GaAs MMIC, Photo Reflector). These products use Gallium (Ga) and Arsenic (As) which are specified as poisonous chemicals by law. For the prevention of a hazard, do not burn, destroy, or process chemically to make them as gas or power. When the product is disposed of, please follow the related regulation and do not mix this with general industrial waste or household waste.
- 13. Please contact our sales representatives should you have any questions or comments concerning the products or the technical information.



Official website

https://www.nisshinbo-microdevices.co.jp/en/

Purchase information

https://www.nisshinbo-microdevices.co.jp/en/buy/